



# Pixel hybrid photon detectors for the LHCb-RICH system

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## ◆ Introduction

- The LHCb detector
- The RICH 2 counter
- Overall RICH system requirements

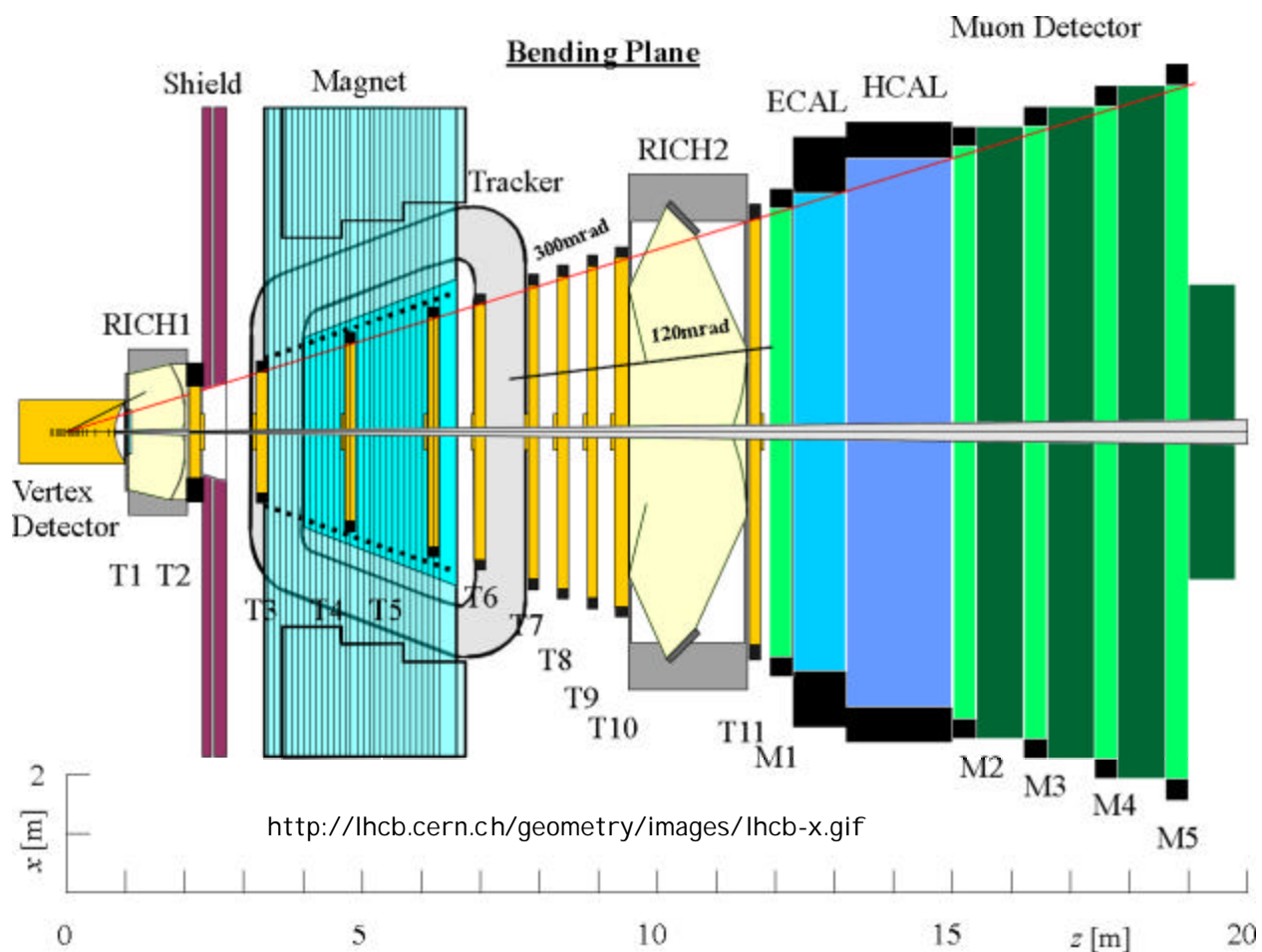
## ◆ The pixel hybrid photon detector

- Description
- Binary front-end electronics
- Full-scale HPD prototypes
- Systematic tests

## ◆ Conclusions and perspectives

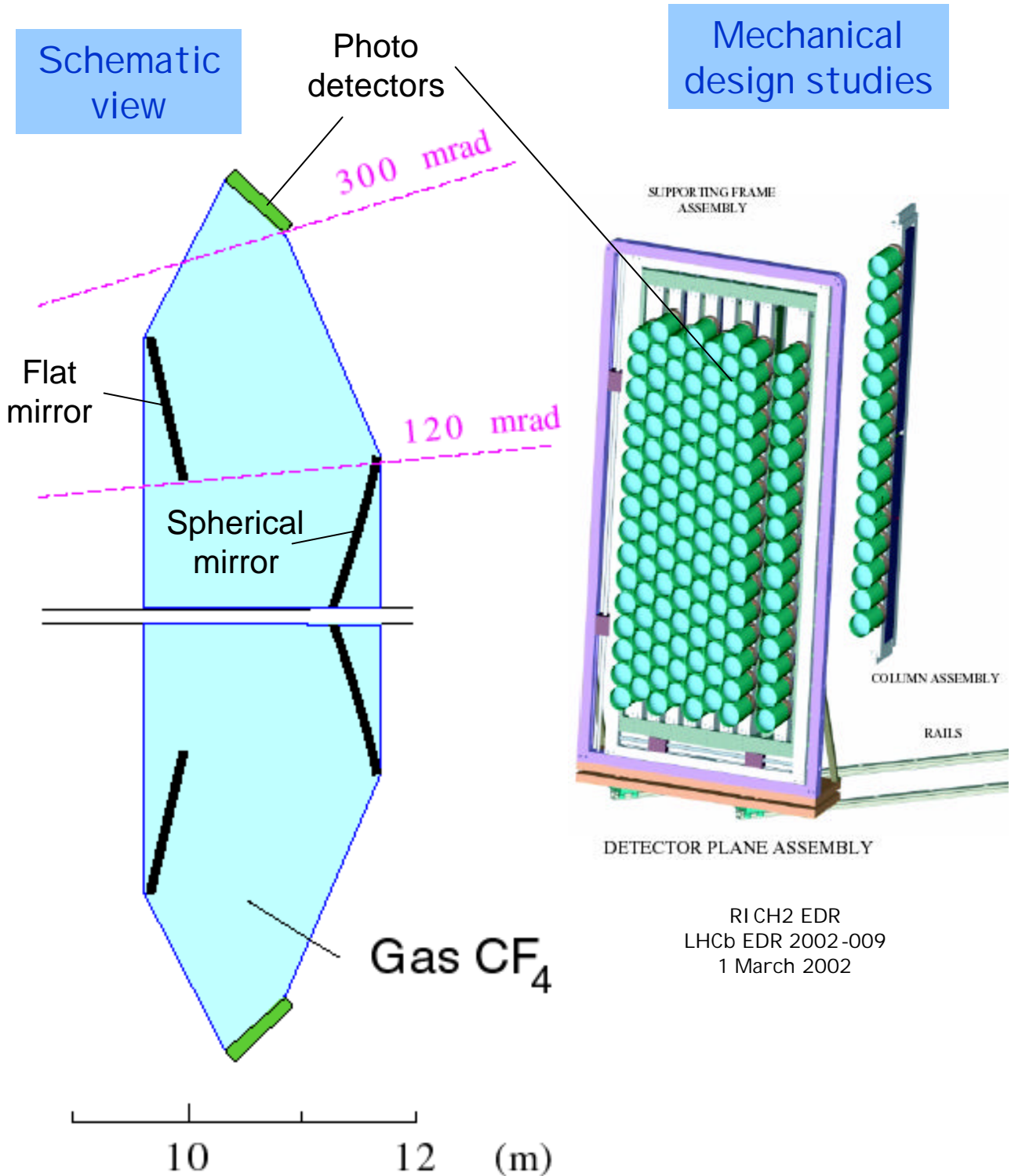
## The LHCb detector (top view)

LHCb is a **single-arm spectrometer** with a forward angular coverage from 10 to 300 mrad, dedicated to **precision studies** of CP asymmetries and of rare decays in the B-meson system



Particle identification over the momentum range 1-150 GeV/c will be achieved by two **Ring Imaging Cherenkov** counters

# The RICH 2 counter

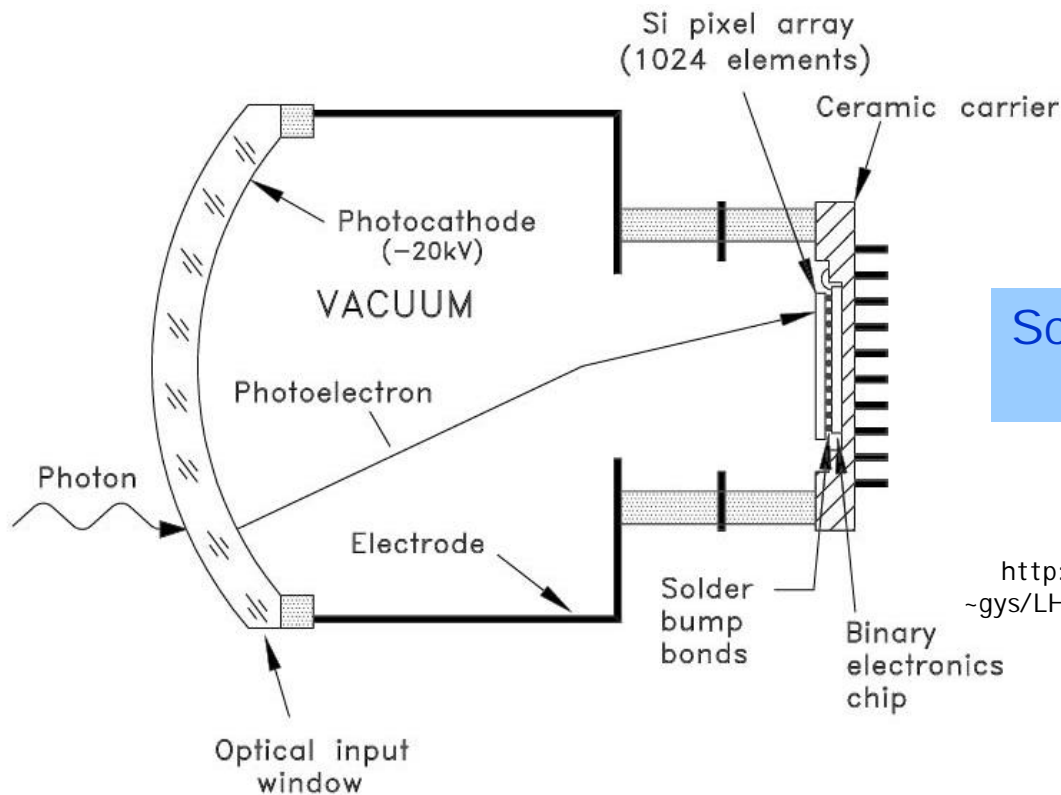


RICH2 EDR  
LHCb EDR 2002-009  
1 March 2002

[http://lhcb.cern.ch/rich/images/rich2\\_schematic.gif](http://lhcb.cern.ch/rich/images/rich2_schematic.gif)

# Overall RICH system requirements

- ◆ Photon detection
  - $\sim 2.9 \text{ m}^2$  total surface
  - Granularity:  $2.5 \times 2.5 \text{ mm}^2$
  - Active area coverage  $\geq 70 \%$  ( $\sim 325'000$  channels)
  - Single-photon sensitivity ( $\lambda = 200\text{-}600 \text{ nm}$ )
  
- ◆ Environment
  - Magnetic stray field:  $\leq 300 \text{ gauss}$  (RICH1)  
 $\leq 100 \text{ gauss}$  (RICH2)
  - Radiation dose:  $\leq 3 \text{ kRad/year}$
  
- ◆ Read-out
  - Maximum occupancy:  $\leq 10 \%$
  - BCO identification ( $\tau_p \approx 25 \text{ ns}$ )
  - High LO-trigger rate ( $1 \text{ MHz}$ )
  
- ◆ Photo-detectors
  - Pixel-HPDs: baseline solution  
cross-focussing geometry  
binary pixel readout (this talk)
  - Multi-anode PMTs: backup solution  
metal channel dynodes  
analogue readout



Schematic view

<http://www.cern.ch/~gys/LHCb/PixelHPDs.htm>

## Main features:

### Close collaboration with industry

Quartz window with thin S20 pK ( $\int QE \cdot dE \approx 0.77 eV$ )

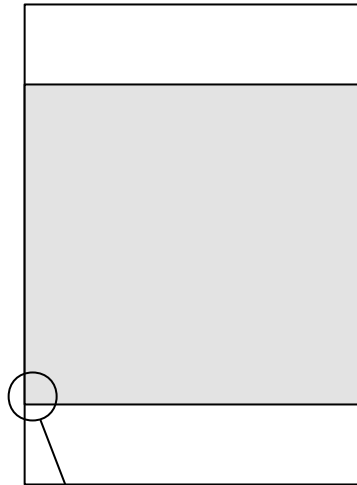
Cross-focussing optics (tetrode structure):

- De-magnification by  $\sim 5$
- $50 \mu m$  PSF ( $\sim 250 \mu m$  at window level)
- Active diameter  $75 mm$  (81.7 % tube coverage)  
 $\Rightarrow \sim 450$  tubes for overall RICH system
- $20 kV$  operating voltage ( $\sim 5000 e^-$  [eq. Si])

$32 \times 32$  pixel sensor array ( $500 \mu m \times 500 \mu m$  each)

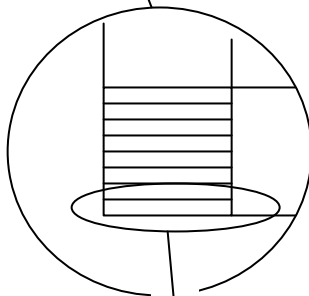
Encapsulated binary electronics readout chip

# Binary front end electronics (baseline specifications)



## Full readout chip

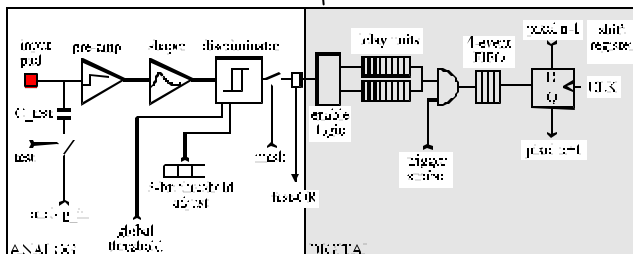
32 × 32 super-pixel array  
 16mm × 16mm active area  
 40MHz readout clock  
 ⇒ ~800ns readout time  
 complying with LHCb LO  
 trigger rate (1MHz)



## Super-pixel

500μm × 500μm area  
 8 sub-pixels ORed together  
 Digital FE electronics:  
 • 16 delay lines (4μs)  
 • 16-deep FIFO de-randomizing buffer  
 ⇒ reduced occupancy seen by  
 analogue FE and lower noise

## Sub-pixel



62.5μm × 500μm area  
 Analogue FE electronics:  
 • Differential amplifier (250 e<sup>-</sup> noise)  
 • Shaper (25 ns peaking time)  
 • Discriminator (2000 e<sup>-</sup> aver.)

See also another contribution of K. Wyllie (this workshop)

## Full-scale pixel-HPD prototypes (1)

Manufactured by *DEP B.V.* (The Netherlands)

### ◆ First prototype (completed in 1999)

- Phosphor screen anode
- CCD readout

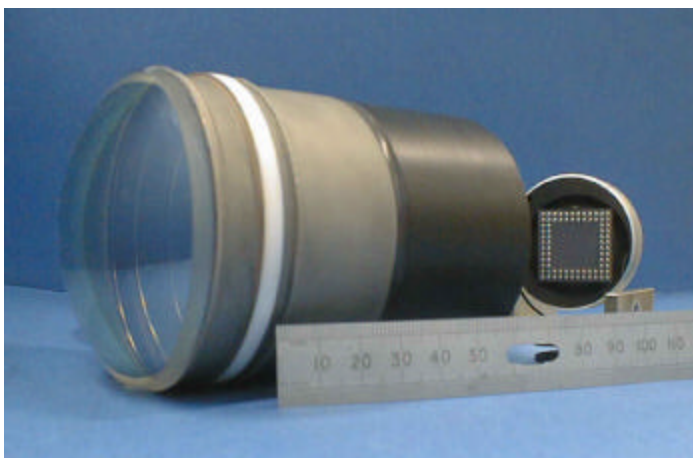
⇒ check of active area, electron-optics, photo-cathode uniformity, magnetic field sensitivity and shielding options.

M. Alemi et al., IEEE Trans. Nucl. Sc. 46,6 (1999) 1901.

### ◆ Second prototype (completed in 1999)

- 61-pixels anode
- External analogue VA2 readout

⇒ check of response to Cherenkov light, installation of a cluster in the RICH prototype.

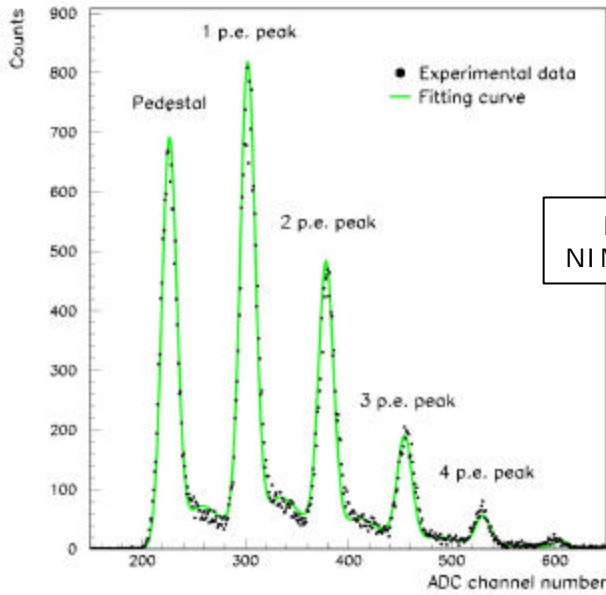


61-pixel HPD  
prototype

[http://www.cern.ch/~gys/  
LHCb/PixelHPDs.htm](http://www.cern.ch/~gys/LHCb/PixelHPDs.htm)



## Laboratory measurements

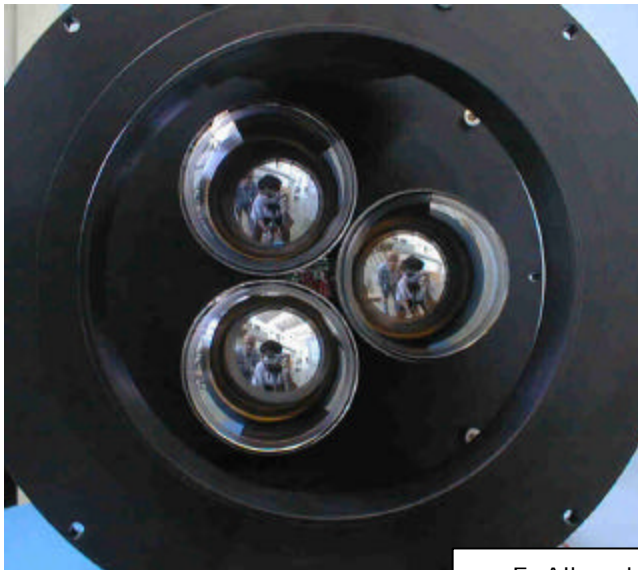


Pulsed LED spectrum

E. Albrecht et al.  
 NI M A 442 (2000) 164

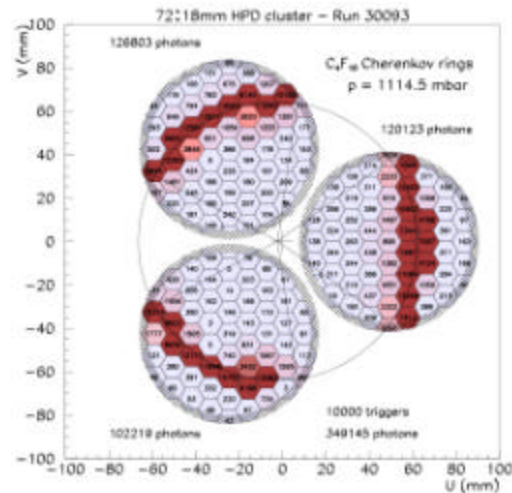
Signal-to-noise ratio  $\approx 11$  @ 20kV  
 with external analogue VA2  
 readout ( $\tau_p = 1.2 \mu s$ )

## Beam tests in LHCb RICH 1 prototype



HPD cluster

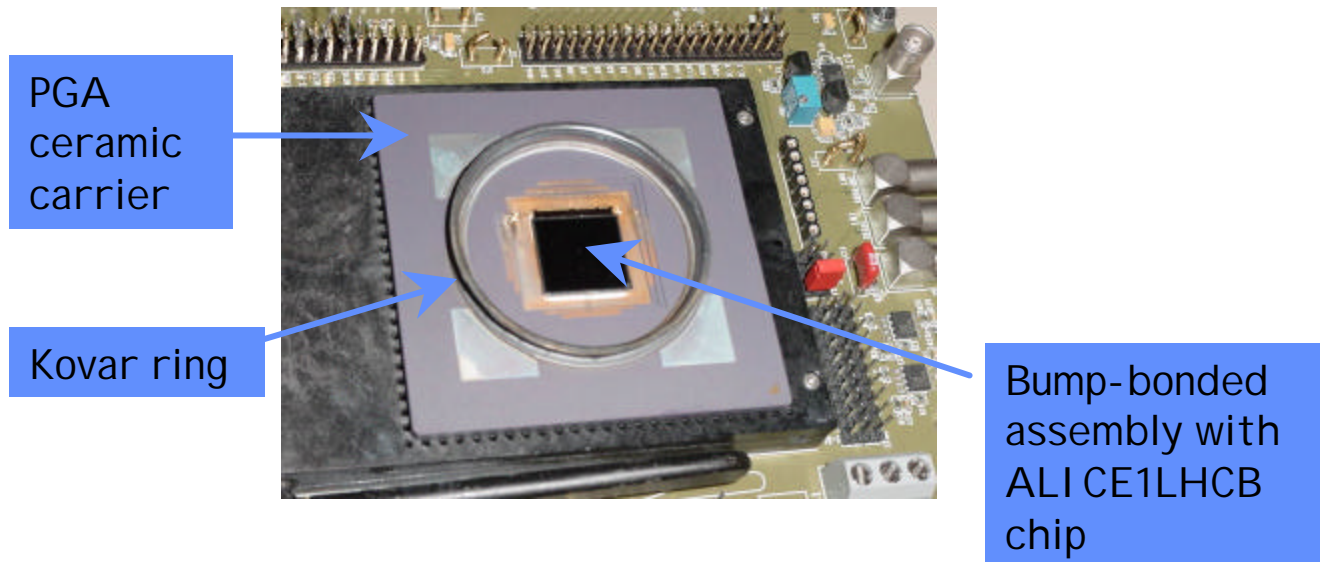
E. Albrecht et al.  
 NI M A 442 (2000) 164



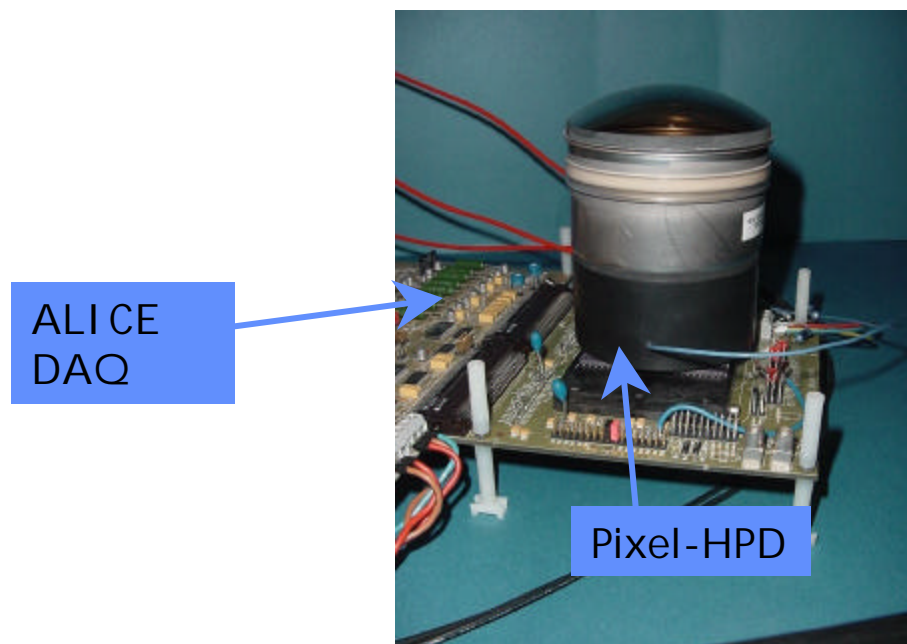
Tube figure of merit:  
 $N_0 \approx 225-250 \text{ cm}^{-1}$

## Full-scale pixel-HPD prototype (3)

- ◆ Third prototype (to be completed in 2001)
  - ALICE1LHCb single assembly anode on custom ceramic carrier



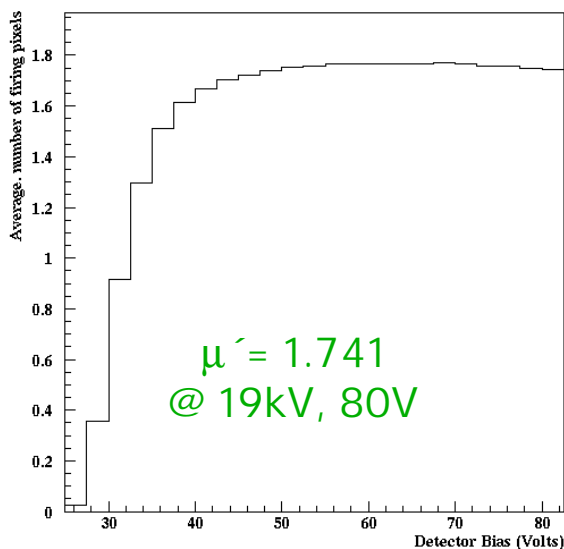
- ALICE DAQ (software+hardware) readout  
⇒ check of response to pulsed LED light.



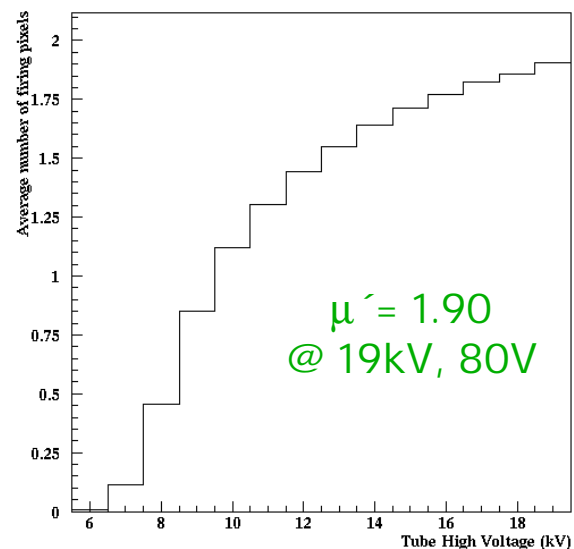
## ◆ Operating conditions

- HPD high voltage = 0  $\Rightarrow$  19kV
- Silicon detector bias 0  $\Rightarrow$  80V
- Back-pulse spectrum recorded at end of data taking
- Temperature and HV remotely controlled and monitored
- Noisy pixels masked
- Missing bump-bonds in central part, due to HPD bake-out cycle  $\Rightarrow$  LED shining window edge

### Detector bias scan

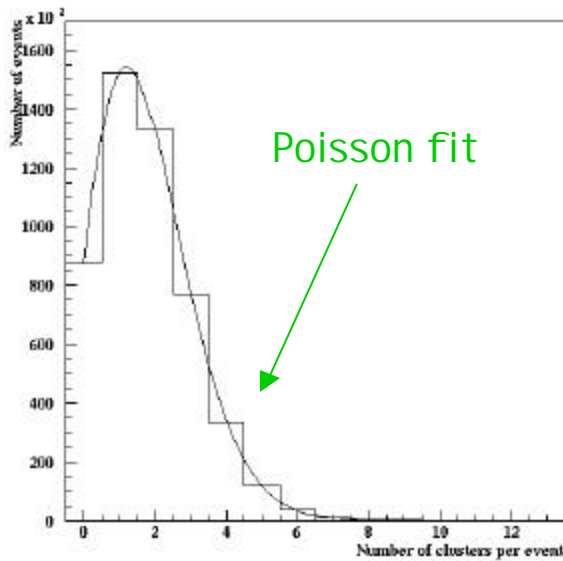


### HV scan

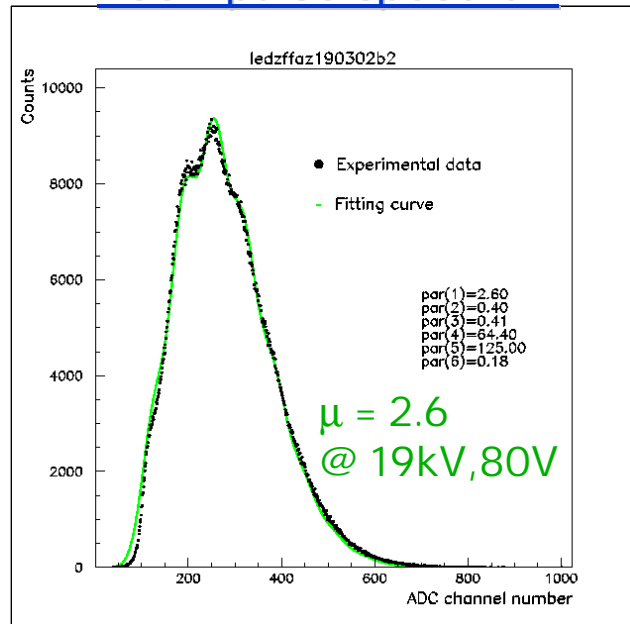


$\mu'$  = average number of firing pixels  
(Poisson statistics)

## Firing pixels per LED pulse

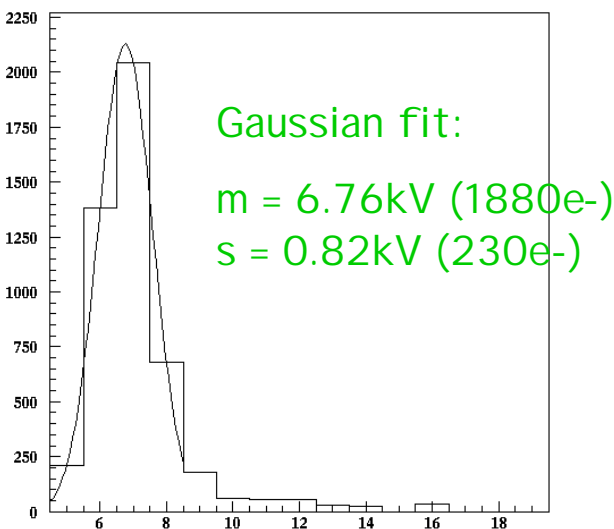


## Back-pulse spectrum



$\mu$  = average number of photoelectrons per LED pulse inferred from back-pulse fit

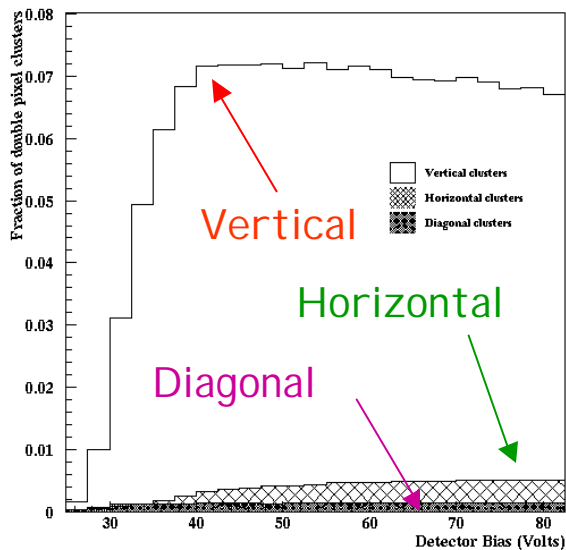
## Differential number of firing pixels as a function of HPD HV (detector bias 80V)



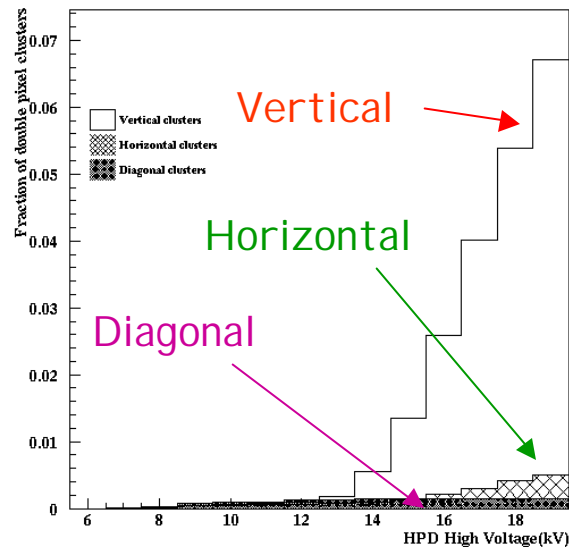
This distribution reflects the comparator threshold distribution of the ALICE1LHCb chip (without threshold adjust)

## Fraction of double pixel clusters as a function of:

### Detector bias voltage



### HPD high voltage



- 1 p.e can cause more than one pixel to fire
- *2-pixel cluster* : two adjacent pixels respond to 1 p.e.:

Horizontal

Vertical

Diagonal

- Vertical 2-pixel clusters are most common due to larger probability of charge sharing along long pixel side

# Systematic tests of pixel-HPD prototype (4)

## ◆ Photoelectron detection efficiency estimate

### ■ Efficiency estimate from baseline specifications:

- Pedestal: 250 e<sup>-</sup> RMS noise
- Threshold: 2000 e<sup>-</sup> aver.
- Signal: 5000 e<sup>-</sup> @ 20kV

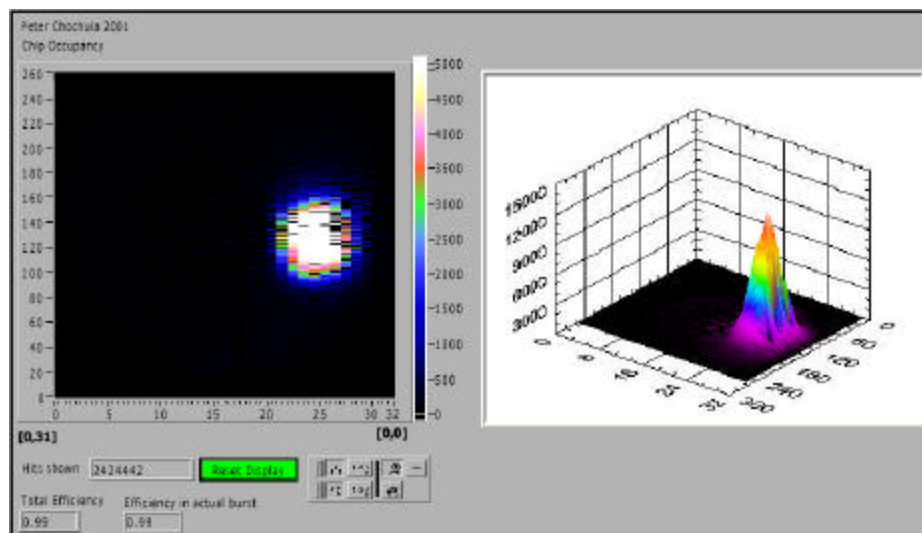
18% back-scattering probability,  $\langle E \rangle = E_0/2$ , reduced effect if low cut

Charge sharing, 7 $\mu$ m RMS lateral spread (300  $\mu$ m-thickness, 90 V bias) not significant if  $E_{cut} < E_0/2$

⇒ ~90 % expected detection efficiency

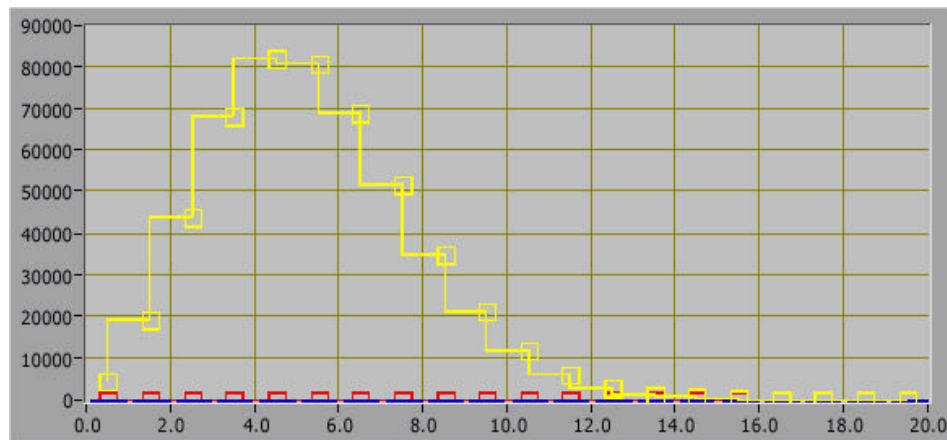
## ◆ Experimental procedure

- LED shining smaller pixel area, where bump-bonds are generally good:



## ◆ Experimental procedure (cont'd)

- Analyze event size, correct for double pixel clusters, infer  $\mu'$ :



- Record back-pulse spectrum, infer  $\mu$  from fit
- Compare values of  $\mu'$  and  $\mu$ ; present estimates range from 81% to 83%; not corrected for LED drift with time, LED tail, missing bump-bonds, masked pixels, photoelectron pile-up
- Error estimates:
  - LED drift: 5-10%
  - Fit parameters: 5%
  - LED tail: a few %



## ◆ Conclusions

- Pixel-HPD with ALICE1LHCb chip **operational**
- General behaviour **nominal**:
  - Good QE: **>23%** @ 270nm
  - HV operation **OK**
  - Chip electrical response: **same** as before encapsulation
  - Detector leakage current: **same** as before encapsulation
  - Heat dissipation: **15 °C** temperature increase for ~0.85W power consumption
- Photoelectron response: **nominal** (**missing bump-bonds excluded**)
  - Preliminary photoelectron efficiency estimates range from 81% to 83%; not corrected for LED drift with time, LED tail, missing bump-bonds, masked pixels, photoelectron pile-up
- **Improved** bump-bonding process **survive** bake-out cycle, new HPD prototypes under manufacturing
- New LHCbPI X1 chip **fully operational** at 40MHz

## ◆ Perspectives

- New silicon pixel detector and ceramic carrier designed, expected for the end of 2002
- New bump-bonded assemblies to be manufactured early 2003